



Product Change Notification

Change Notification #: 117954 - 01
Change Title: Select Field Programmable Gate Array (FPGA) and Complex Programmable Logic Device (CPLD) product families, PCN 117954-01, Product Discontinuance, End of Life
Reason for Revision: Removed MAX II, MAX II G & MAX II Z from the list of impacted products and updated Reason for Change section
Date of Publication: March 22, 2021

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Device Family	Last Order Acceptance ⁽¹⁾	Last Time Shipments
Arria GX	June 4, 2021	Dec 6, 2021
Stratix II	June 4, 2021	Dec 6, 2021
Stratix II GX	June 4, 2021	Dec 6, 2021
MAX 7000A	June 4, 2021	Dec 6, 2021
MAX II (including MAX II G/Z)	June 4, 2021	Dec 6, 2021

⁽¹⁾ Due to production support limitation, the last time buy orders are subjected to available inventory. Orders will become non-cancellable, non-reschedule, non-returnable on the last order acceptance date.

Description of Change to the Customer:

Reason for Revision:

This is the same revised product discontinuance notice described in PDN2041 issued on March 19, 2021.

The purpose of this revision is to remove MAX II (including MAX II G & MAX II Z) from the list of impacted products. Intel's current estimate is that MAX II products will be reviewed for EOL in 2024.

Intel is discontinuing Arria GX, Stratix II, Stratix II GX & MAX 7000A Field Programmable Gate Array (FPGA) and Complex Programmable Logic Device (CPLD) product families.

Reason for Change

- Arria GX, Stratix II and Stratix II GX are being discontinued due to Intel’s vendor phasing out its production line capacity for flip chip eutectic tin-lead bumps as 1st level interconnect. Full RoHS compliant leadfree replacement packages are not offered due to shift in demand and volumes.
- MAX 7000A is being discontinued due to shift in demand and volumes.
- MAX II is removed from the list of impacted products after considering customer feedback and current supply uncertainty in the broader semiconductor market.

Customer Impact of Change and Recommended Action:

Customers are advised to perform a last time buy on the ordering part numbers (OPNs) impacted by this discontinuance notice. There are no replacement devices available.

For more information and assistance, please contact Sales or Customer Service in your region.

Products Affected / Intel Ordering Codes:

The list of affected Ordering Part Numbers (OPNs) can be downloaded here:

<https://www.intel.com/content/dam/www/programmable/us/en/pdfs/literature/pcn/pdn2041-opn-list.xlsx>

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
December 11, 2020	00	Originally Published PCN
March 22, 2021	01	Removed MAX II, MAX II G & MAX II Z from the list of impacted products and updated Reason for Change section



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

Asia Pacific/PRC Contact: apacgccb@intel.com

Europe Email: eccb@intel.com

Japan Email: jccb.ijkk@intel.com

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